

## Rectifier Diode Module Types MDO1200-20N1 to MDO1200-22N1

### Absolute Maximum Ratings

$V_{RRM}$ [V]	Type
2000	MDO1200-20N1
2200	MDO1200-22N1

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
$V_{RRM}$	Repetitive peak reverse voltage <sup>1)</sup>	2000-2200	V
$V_{RSM}$	Non-repetitive peak reverse voltage <sup>1)</sup>	2100-2300	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
$I_{F(AV)M}$	Maximum average forward current, $T_c=55^\circ\text{C}$ <sup>2)</sup>	1888	A
$I_{F(AV)M}$	Maximum average forward current, $T_c=102^\circ\text{C}$ <sup>2)</sup>	1200	
$I_{F(AV)M}$	Maximum average forward current, $T_c=85^\circ\text{C}$ <sup>2)</sup>	1468	
$I_{F(RMS)M}$	Nominal RMS forward current, $T_c=25^\circ\text{C}$ <sup>2)</sup>	3557	
$I_{T(d.c.)}$	D.C. forward current, $T_c=25^\circ\text{C}$ <sup>2)</sup>	2836	
$I_{FSM}$	Peak non-repetitive surge $t_p=10\text{ms}$ , $V_{rm}=60\%V_{RRM}$ <sup>3)</sup>	36.4	kA
$I_{FSM2}$	Peak non-repetitive surge $t_p=10\text{ms}$ , $V_{rm}\leq 10\text{V}$ <sup>3)</sup>	40.0	kA
$I^2t$	$I^2t$ capacity for fusing $t_p=10\text{ms}$ , $V_{rm}=60\%V_{RRM}$ <sup>3)</sup>	$6.62\times 10^6$	$\text{A}^2\text{s}$
$I^2t$	$I^2t$ capacity for fusing $t_p=10\text{ms}$ , $V_{rm}\leq 10\text{V}$ <sup>3)</sup>	$8.00\times 10^6$	$\text{A}^2\text{s}$
$V_{ISOL}$	Isolation Voltage <sup>4)</sup>	3500	V
$T_{vj\text{ op}}$	Operating temperature range	-40 to +160	$^\circ\text{C}$
$T_{stg}$	Storage temperature range	-55 to +160	$^\circ\text{C}$

**Notes:**

- 1) De-rating factor of 0.13% per  $^\circ\text{C}$  is applicable for  $T_{vj}$  below  $25^\circ\text{C}$ .
- 2) Single phase; 50 Hz,  $180^\circ$  half-sinewave.
- 3) Half-sinewave,  $160^\circ\text{C}$   $T_{vj}$  initial.
- 4) AC RMS voltage, 50 Hz, 1min test

**Characteristics**

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS <sup>1)</sup>	UNITS
V <sub>FM</sub>	Maximum peak forward voltage	-	-	1.35	I <sub>FM</sub> =3000A	V
		-	-	1.44	I <sub>FM</sub> =3600A	V
V <sub>T0</sub>	Threshold voltage	-	-	0.872		V
r <sub>T</sub>	Slope resistance	-	-	0.107		mΩ
I <sub>RRM</sub>	Peak reverse current	-	-	2	Rated V <sub>RRM</sub> , T <sub>J</sub> =25°C	
		-	-	100	Rated V <sub>RRM</sub>	
Q <sub>rr</sub>	Recovered Charge	-	4000	-		μC
Q <sub>ra</sub>	Recovered Charge, 50% chord	-	3300	3800	I <sub>FM</sub> =1000A, t <sub>p</sub> =1000μs, di/dt=10A/μs, V <sub>r</sub> =50V	μC
I <sub>rm</sub>	Reverse recovery current	-	200	-		A
t <sub>rr</sub>	Reverse recovery time, 50% chord	-	33	-		μs
R <sub>thJC</sub>	Thermal resistance, junction to case	-	-	0.0405		
R <sub>thCH</sub>	Thermal resistance, case to heatsink	-	-	0.0100		K/W
F <sub>1</sub>	Mounting torque (to heatsink)	5.1	-	6.9		Nm
F <sub>2</sub>	Mounting torque (to terminals)	16.2	-	19.8		Nm
W <sub>t</sub>	Weight	-	2.2	-		kg

**Notes:**

1) Unless otherwise indicated T<sub>vj</sub>=160°C.

## Notes on Ratings and Characteristics

### 1.0 Voltage Grade Table

Voltage Grade	$V_{RRM}$ V	$V_{RSM}$ V	$V_R$ DC V
20	2000	2100	1250
22	2200	2300	1350

### 2.0 Extension of Voltage Grades

This report is applicable to other voltage grades when supply has been agreed by Sales/Production.

### 3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for  $T_{vj}$  below 25°C.

### 4.0 Repetitive dv/dt

Standard dv/dt is 1000V/μs.

### 5.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

### 6.0 Computer Modelling Parameters

#### 6.1 Diode dissipation calculations

$$I_{AV} = \frac{-V_{T0} + \sqrt{V_{T0}^2 + 4 \cdot ff^2 \cdot r_T \cdot W_{AV}}}{2 \cdot ff^2 \cdot r_T} \quad \text{and:} \quad W_{AV} = \frac{\Delta T}{R_{th}}$$

$$\Delta T = T_{j\max} - T_C$$

Where  $V_{T0} = 0.872$  V,  $r_T = 0.107$  mΩ.

$R_{th}$  = Supplementary thermal impedance, see table below and

$ff$  = Form factor, see table below.

Supplementary Thermal Impedance				
Conduction Angle	6 phase (60°)	3 phase (120°)	½ wave (180°)	d.c.
Square wave	0.0449	0.0433	0.0423	0.0405
Sine wave	0.0439	0.0421	0.0409	

Form Factors				
Conduction Angle	6 phase (60°)	3 phase (120°)	½ wave (180°)	d.c.
Square wave	2.449	1.732	1.414	1
Sine wave	2.778	1.879	1.57	

6.2 Calculating diode  $V_F$  using ABCD coefficients – For loss calculations

The forward characteristic,  $I_F$  vs.  $V_F$ , is represented in two ways;

- (i) the well established  $V_{T0}$  and  $r_T$  tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the equation for  $V_F$  in terms of  $I_T$  given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

The ABCD constants are given below for both hot and cold characteristics. The resulting values for  $V_F$  agree with the true device characteristic over a current range, which is limited to that plotted.

25°C Coefficients		160°C Coefficients	
A	0.8219376	A	0.6177319
B	0.02800357	B	0.02398102
C	$4.58252 \times 10^{-5}$	C	$4.93957 \times 10^{-5}$
D	$2.125018 \times 10^{-3}$	D	$4.419761 \times 10^{-3}$

6.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left( 1 - e^{-\frac{t}{\tau_p}} \right)$$

$n$  = number of terms in the series and  
 $t$  = duration of heating pulse in seconds.  
 $r_t$  = thermal resistance at time  $t$ .

$r_p$  = Amplitude of  $p_{th}$  term.  
 $\tau_p$  = Time Constant of  $r_{th}$  term.

The coefficients for this device are shown in the tables below:

D.C. Junction to Case						
Term	1	2	3	4	5	6
$r_p$	$1.0 \times 10^{-5}$	0.016708	0.018317	$4.346771 \times 10^{-3}$	$1.004820 \times 10^{-3}$	$1.0 \times 10^{-5}$
$\tau_p$	2.460066	0.999836	21.998376	$9.793053 \times 10^{-3}$	2.003674	5.007343

7.0 Reverse recovery ratings

- (i)  $Q_{ra}$  is based on 50%  $I_{RM}$  chord as shown in Fig. 1

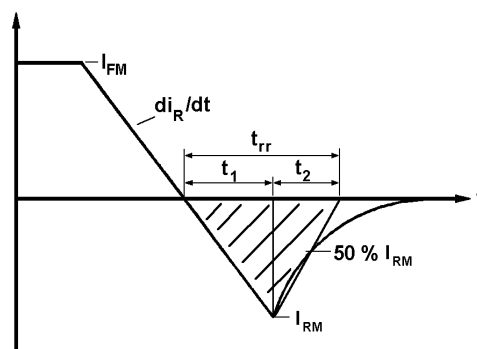


Fig. 1

- (ii)  $Q_{rr}$  is based on a 150  $\mu s$  integration time i.e.

$$Q_{rr} = \int_0^{150 \mu s} i_{rr} \cdot dt$$

- (iii)

$$K \text{ Factor} = \frac{t_1}{t_2}$$

**Curves**

Figure 1 – Forward Characteristics of Limit Device

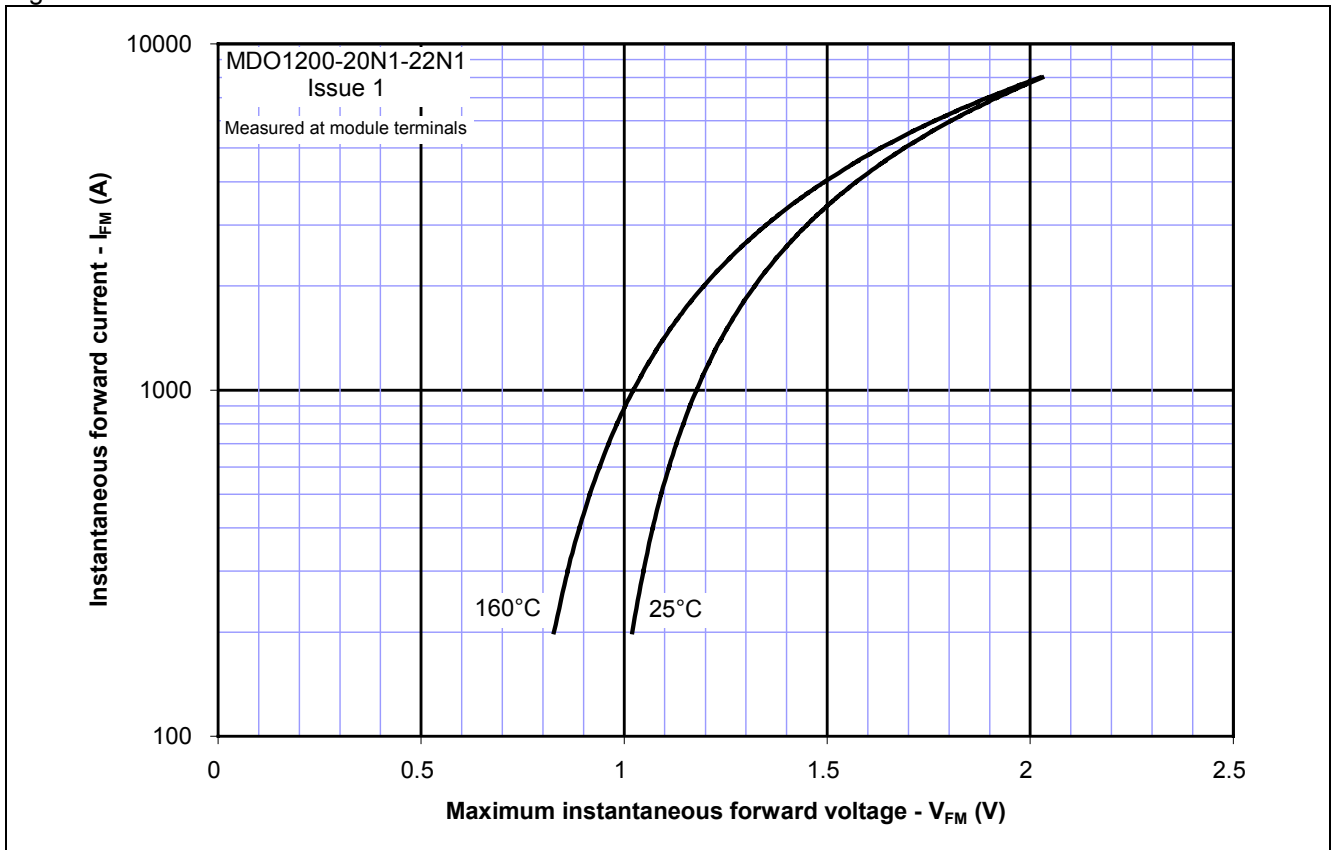


Figure 2 – Transient Thermal Impedance

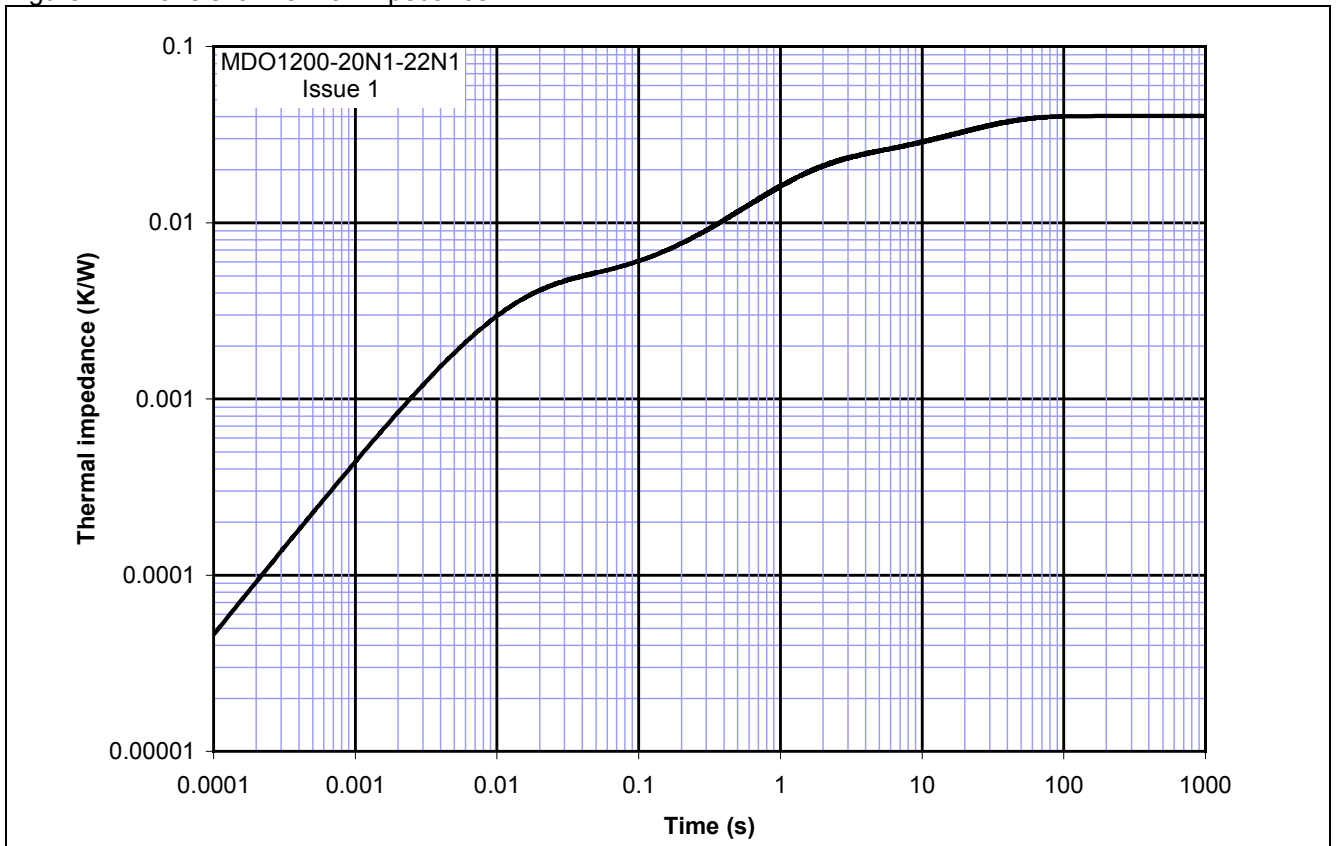


Figure 3 – Total recovered charge,  $Q_{rr}$

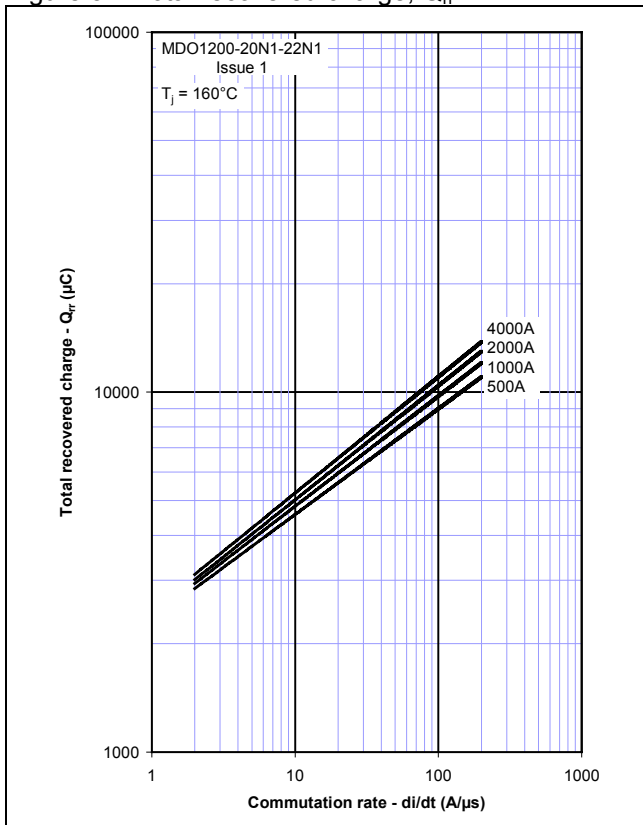


Figure 4 – Recovered charge,  $Q_{ra}$  (50% chord)

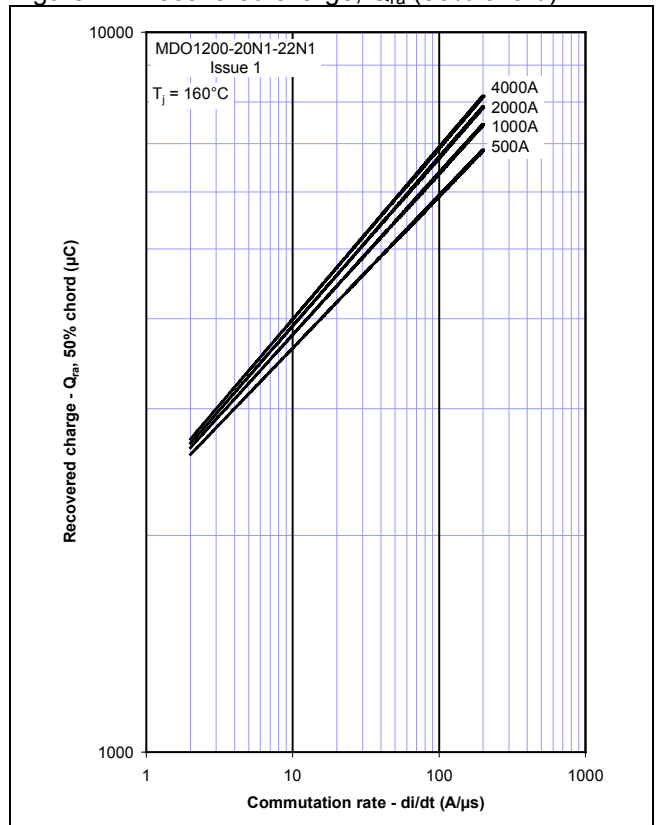


Figure 5 – Peak reverse recovery current,  $I_{rm}$

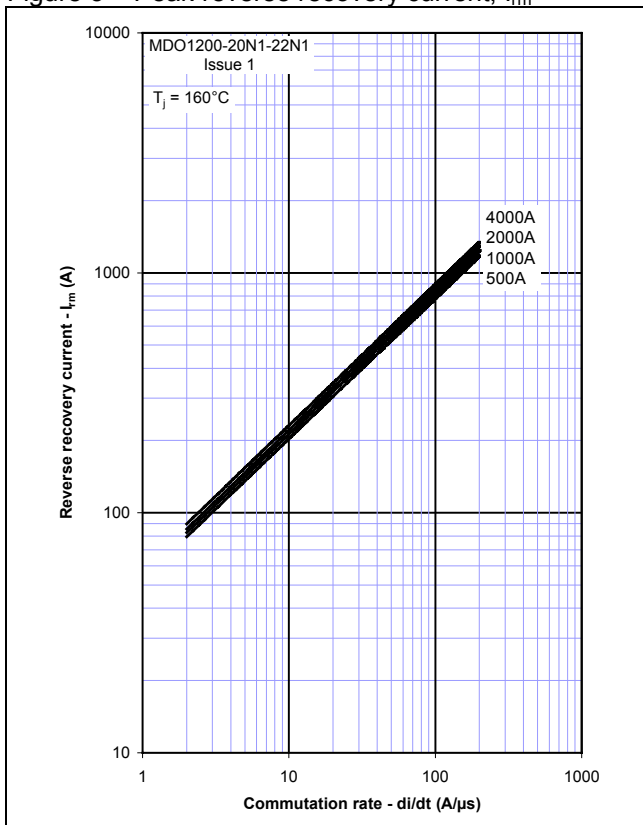


Figure 6 – Maximum recovery time,  $t_{rr}$  (50% chord)

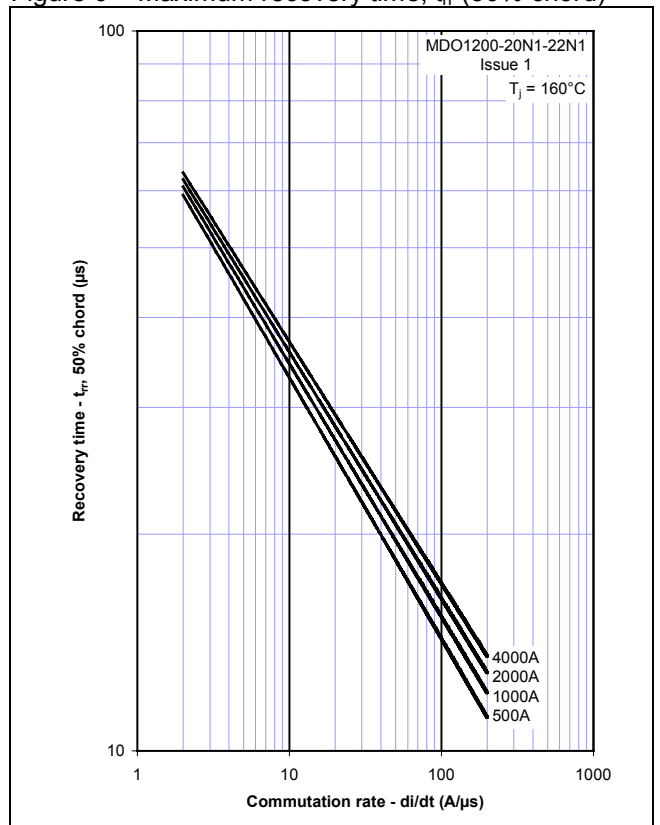


Figure 7 – Forward current vs. Power dissipation

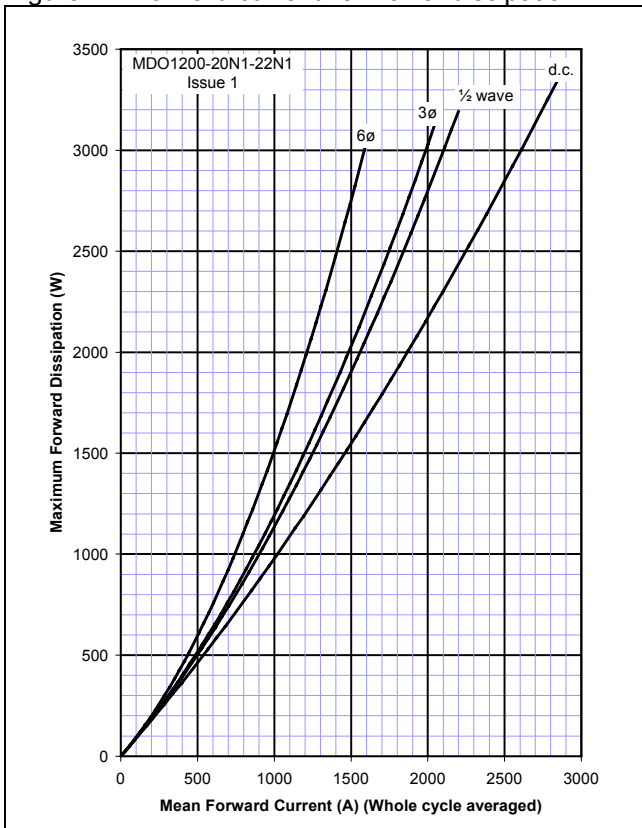


Figure 8 – Forward current vs. Heatsink temperature

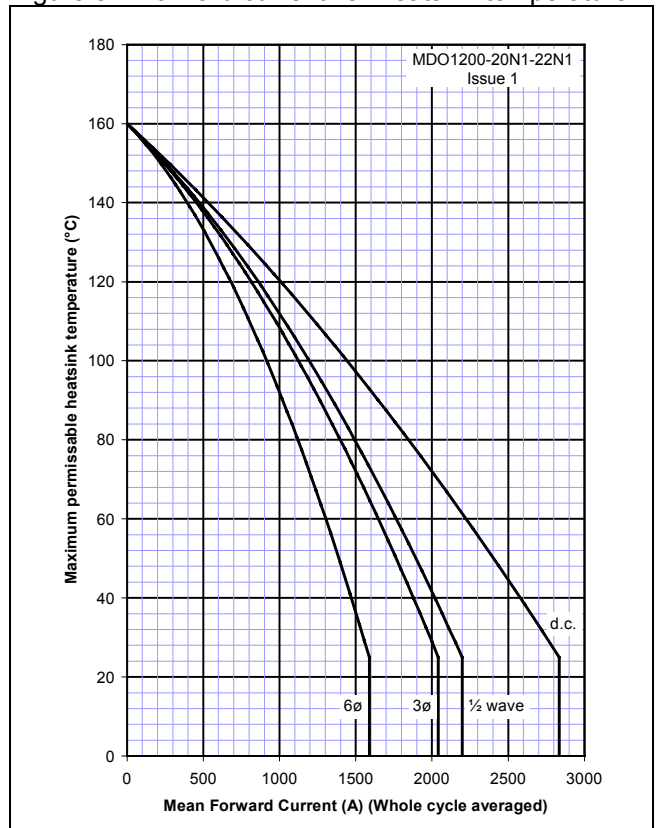
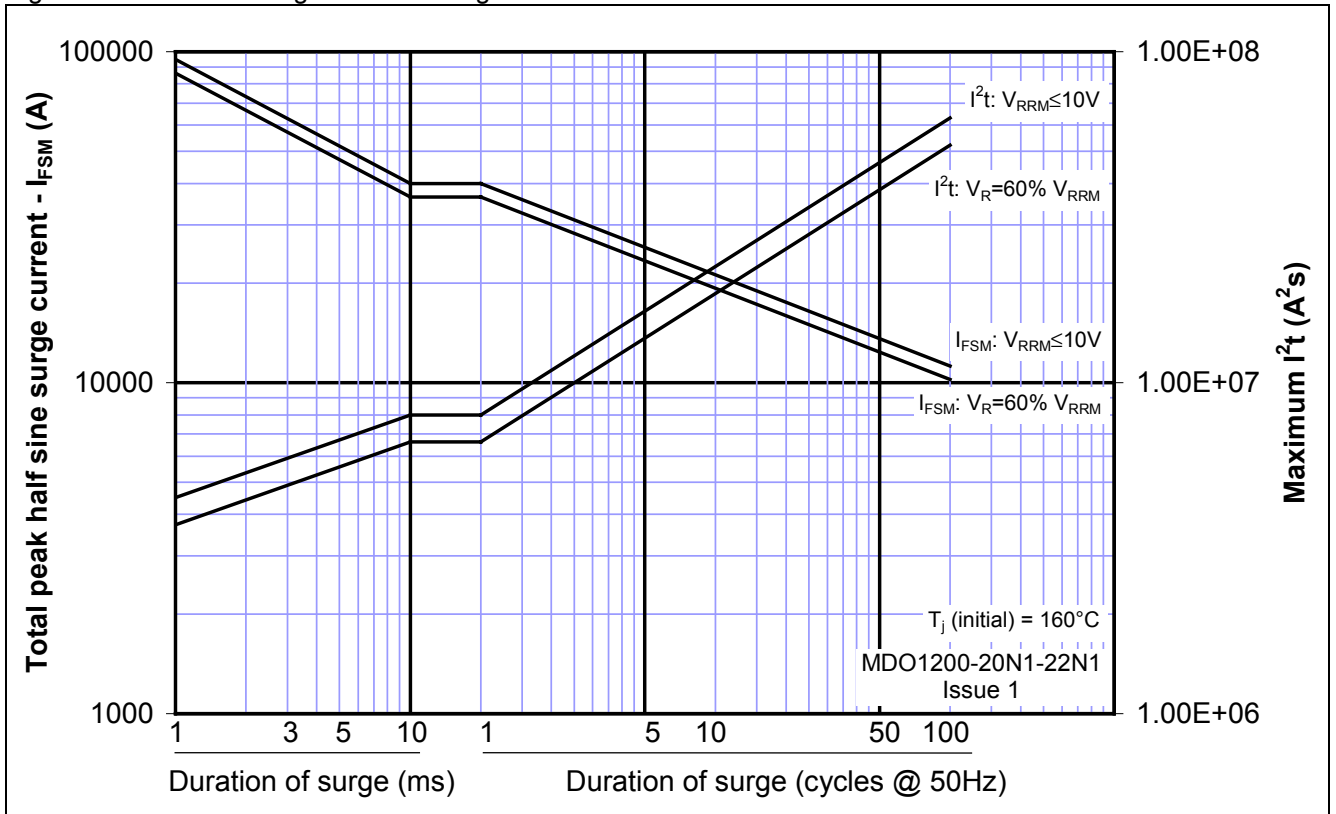
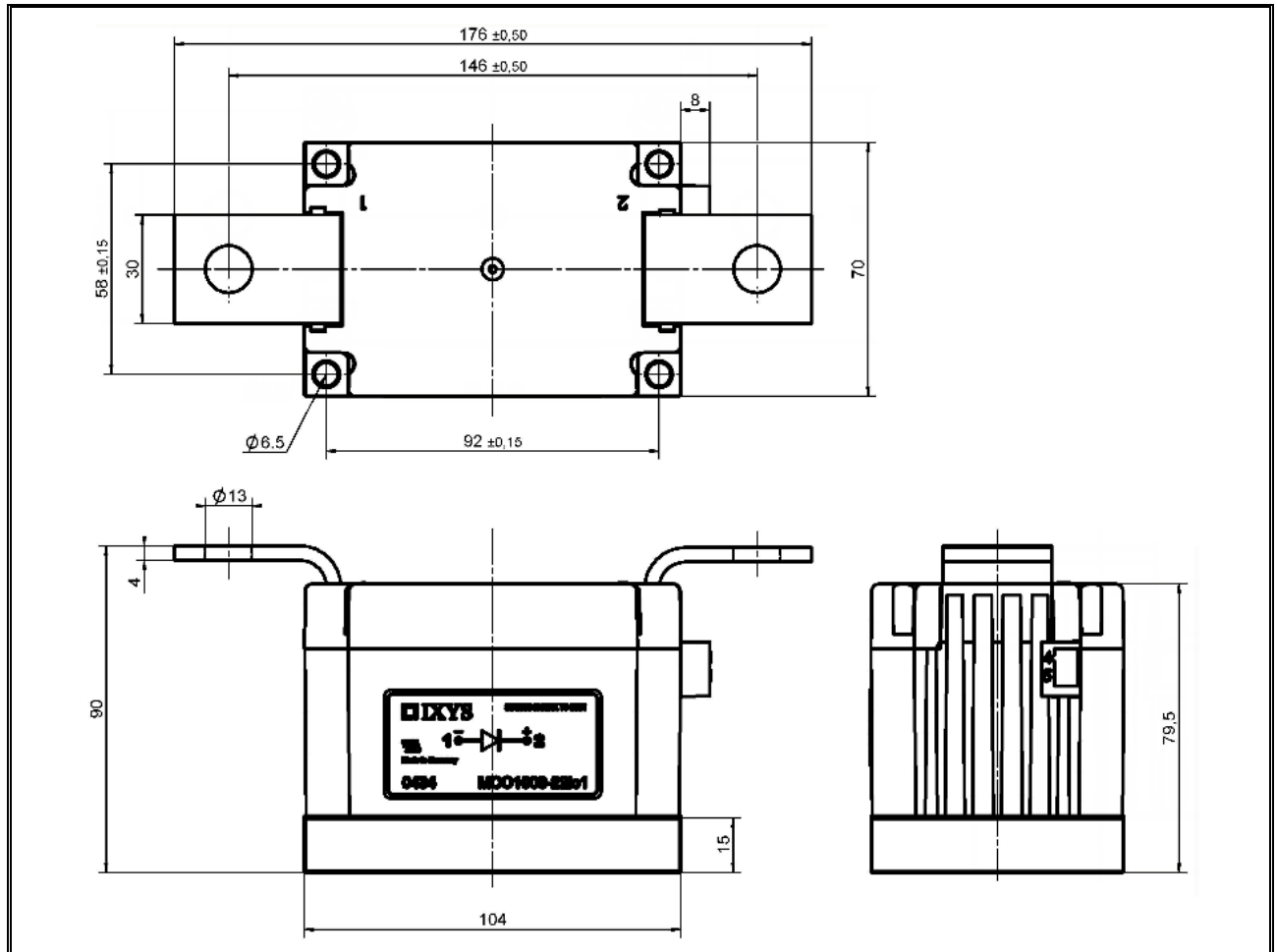


Figure 9 – Maximum surge and I<sup>2</sup>t Ratings



**Outline Drawing & Ordering Information**



**ORDERING INFORMATION**

(Please quote 11 digit code as below)

<b>M</b>	<b>DO</b>	<b>1200</b>	<b>◆◆</b>	<b>N</b>	<b>1</b>
Fixed Type Code	Fixed Configuration code	Nominal Current Rating	Voltage code $V_{RRM}/100$ 20-22	Standard diode	Fixed Version Code

Typical order code: MDO1200-22N1, 1600V  $V_{RRM}$  Rectifier Diode Module

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